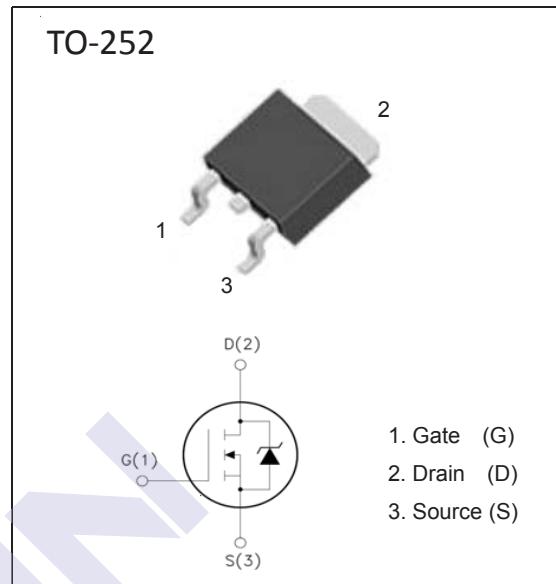


N-Channel MOSFET**2KK5062****■ Features**

- $BV_{DSS} = 150V$, $I_D = 20A$
- $R_{DS(ON)} < 80m\Omega$ @ $V_{GS}=10V$, $I_D=10A$
- High Switching Speed
- Low gate charge

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	20	A
Pulsed Drain Current ($t_p \leq 10\mu s$)	I_{DM}	60	
Single Pulse Avalanche Energy	E_{AS}	60	mJ
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	110	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	
Maximum Power Dissipation	P_D	50	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^{\circ}\text{C}$

2KK5062

■ Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{Id}=250\mu\text{A}, \text{V}_{\text{GS}}=0\text{V}$	150			V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=150\text{V}, \text{V}_{\text{GS}}=0\text{V}$			1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{DS}}=0\text{V}, \text{V}_{\text{GS}}=\pm 20\text{V}$			± 100	nA
On Characteristics (Note 1)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{Id}=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-Resistance	$\text{R}_{\text{DS}(\text{on})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{Id}=20\text{A}$			80	$\text{m}\Omega$
Dynamic Characteristics						
Input Capacitance	C_{iss}	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$		1133	1627	pF
Output Capacitance	C_{oss}			332	474	
Reverse Transfer Capacitance	C_{rss}			105	174	
Switching Characteristics (Note 2)						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=75\text{V}, \text{Id}=20\text{A}, \text{V}_{\text{GS}}=10\text{V}, \text{R}_g=9.1\Omega$		11	25	ns
Turn-On Rise Time	t_r			77	153	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			33	67	
Turn-Off Fall Time	t_f			49	97	
Total Gate Charge	Q_g	$\text{V}_{\text{DS}}=75\text{V}, \text{Id}=20\text{A}, \text{V}_{\text{GS}}=10\text{V}$		39.1	55.9	nC
Gate Source Charge	Q_{gs}			7.5		
Gate Drain Charge	Q_{gd}			22		
Drain-Source Diode Characteristics						
Body Diode Voltage	V_{SD}	$\text{I}_{\text{s}}=20\text{A}, \text{V}_{\text{GS}}=0\text{V}$			1.5	V
Diode Forward Current	I_{s}				20	A
Body Diode Reverse Recovery Time	t_{rr}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{s}} = 20 \text{ A}, \text{dI/dt} = 100 \text{ A}/\mu\text{s}$		160		ns
Body Diode Reverse Recovery Charge	Q_{rr}			1.1		μC

Notes:

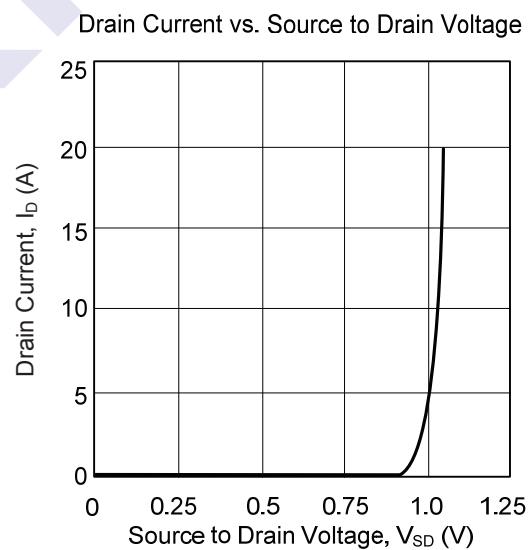
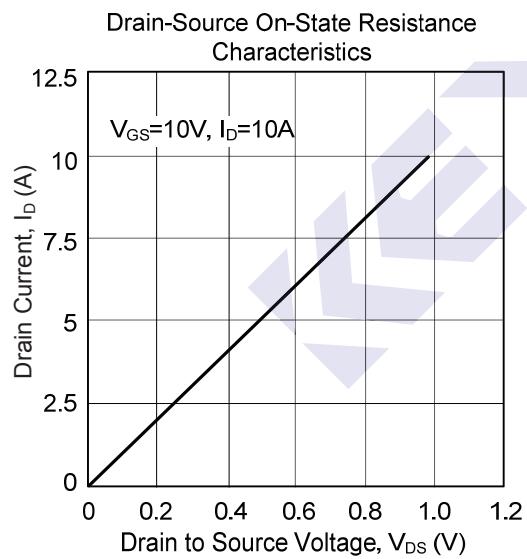
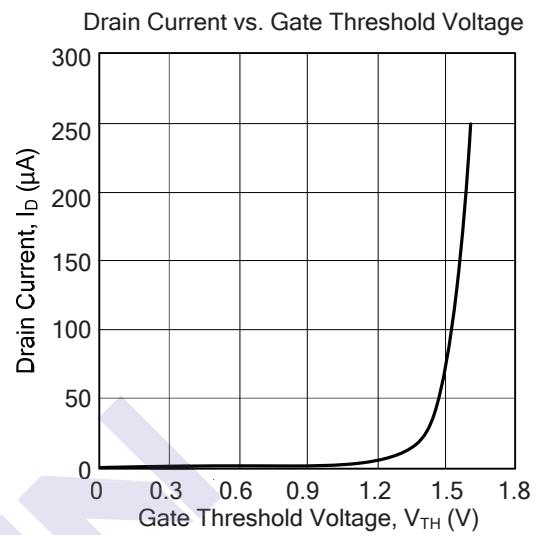
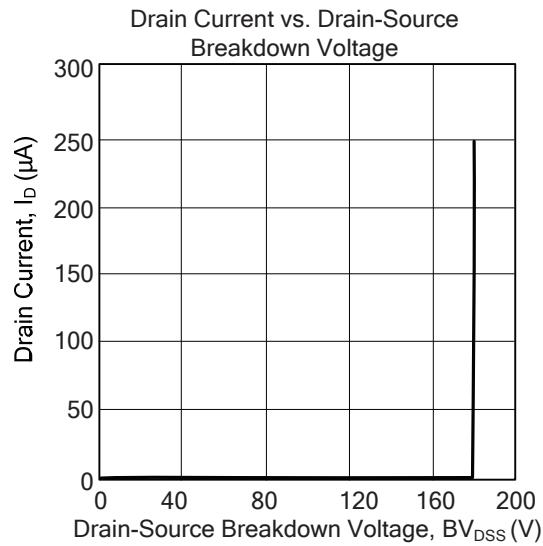
1. Pulse Test: Pulse Width $\leqslant 300\mu\text{s}$, Duty Cycle $\leqslant 2\%$.
2. Switching characteristics are independent of operating junction temperature.

■ Marking

Marking	K5062 K****
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2KK5062

■ Typical Characteristics

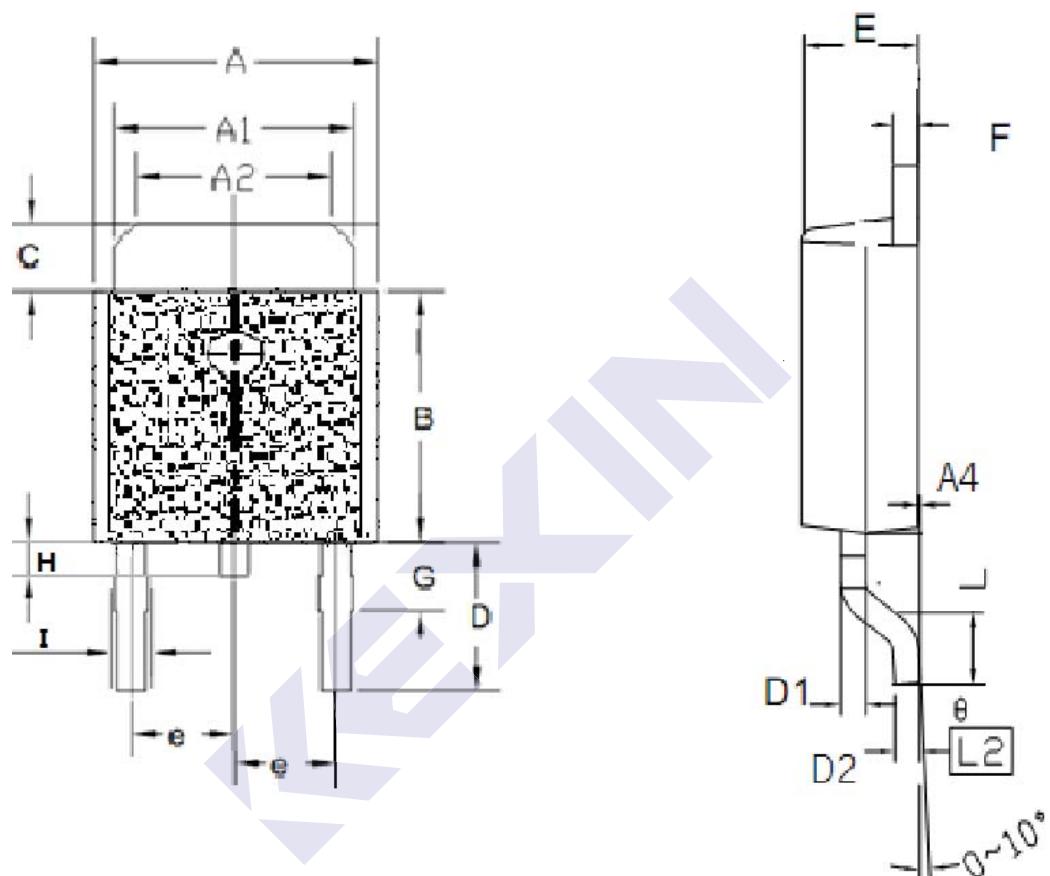


2KK5062

■ Package Dimension

TO-252

Units: mm



Symbol	Min	Max	Symbol	Min	Max
A	6.40	6.60	D	2.90	3.10
A1	5.20	5.40	D1	0.45	0.55
A2	4.40	4.60	D2	0.45	0.55
A3	4.40	4.60	e		2.30
A4	0.00	0.15	E	2.20	2.40
A5	4.65	4.95	F	0.49	0.59
B	6.00	6.20	G		1.70
B1	1.57	1.77	L	1.40	1.60
C	0.90	0.96	θ(°)	0.00	10.00
I	0.60	0.90	H	0.49	0.52